# **SI-3018LSA**

#### 8 OUT IN INTERNAL ( 7 OUT 2 |IC CONNECTION VR SUB SUPPLY 3 Vs 6 GND GND ENABLE Dwg. PK-012 **ABSOLUTE MAXIMUM RATINGS** Input Voltage, V<sub>1</sub>..... 16 V Supply Voltage, V<sub>S</sub> ..... 16 V Continuous Output Current, Io ...... 1.0 A\* Logic Input Voltage, V<sub>E</sub> ..... V<sub>s</sub> Package Power Dissipation, P<sub>D</sub>..... See Graph Output Junction Temperature. T<sub>1</sub> ..... +150°C† Operating Temperature Range, T<sub>A</sub> ..... -30°C to +100°C Storage Temperature Range, T<sub>stg</sub> ..... -30°C to +150°C

\* Output current rating may be limited by duty cycle, ambient temperature, and heat sinking. Under any set of conditions, do not exceed the specified current rating or a junction temperature of 150°C.

† Fault conditions that produce excessive junction temperature will activate the device's thermal protection circuitry. These conditions can be tolerated but should be avoided.

### LOW-VOLTAGE, HIGH-CURRENT 1.8 V LINEAR REGULATOR

The SI-3018LSA is designed to meet the requirement for increased integration and reliability in low-voltage, high-current, linear regulator applications such as personal computers (PCs) and set-top boxes. Each device incorporates a monolithic low-level reference and control circuit with a high-current pnp transistor in a power multi-chip module (PMCM<sup>TM</sup>). Regulated output voltages of 2.5 V or 3.3 V are also available.

The high-current pass element provides a low dropout voltage with output current to 1 A. Regulator accuracy of  $\pm 2$  % and excellent temperature characteristics are provided. The logic-compatible ENABLE input gives the designer complete control over power up, power down, and standby or sleep.

These devices are supplied in a fully molded 8-lead miniature surface-mount package (tape and reel) with enhanced power-dissipating qualities. They are rated for continuous operation between -30°C and +100°C.

#### FEATURES

- 1 A Output Current
- Low Dropout voltage
- LSTTL/CMOS-Compatible On/Off Control Less Than 1 µA "Sleep" Current
- Internal Foldback Overcurrent Limiting
- Internal Thermal Protection
- Surface-Mount Package

Always order by complete part number: SI-3018LSA-TL where "-TL" indicates tape and reel.







1.5 ALLOWABLE PACKAGE POWER DISSIPATION in WATTS 56.5 mm x 56.5 mm COPPER AREA ON GLASS-EPOXY BOARD 1.0 40 mm x 40 mm COPPER AREA ON GLASS-EPOXY BOARD 28 mm x 28 mm COPPER AREA ON GLASS-EPOXY BOARD 0.5 20 mm x 20 mm COPPER AREA ON GLASS-EPOXY BOARD 0 0 20 40 0 60 80 AMBIENT TEMPERATURE in °C 100 120 140 Dwg. GK-010-1

Leads 7 and 8 are soldered to the copper area and provide heat sinking of the pass transistor.

#### **RECOMMENDED OPERATING CONDITIONS**

Max. Input Voltage, V <sub>1</sub>	3.5 V
Output Current, I <sub>O</sub>	0 A to 1.0 A
Output Junction Temperature Range, $\rm T_J$ $\cdot$	-20 °C to +125°C
Ambient Temperature Range, T <sub>A</sub>	-30°C to +85°C



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# **ELECTRICAL CHARACTERISTICS** at $T_A = +25$ °C, $V_I = V_S = 3.3$ V, $V_E = 2.0$ V (unless otherwise noted).

			Limits			
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Output Voltage	Vo	I <sub>o</sub> = 500 mA	1.764	1.800	1.836	V
	V <sub>oq</sub>	V <sub>E</sub> = 0 V, Output Off	_	_	0.5	V
Output Volt. Temp. Coeff.	a <sub>vo</sub>	$I_{O}$ = 5 mA, 0°C $\leq$ T <sub>J</sub> $\leq$ 100°C	_	±0.3	_	mV/°C
Overcurrent Limit	I <sub>OM</sub>	$V_{\rm O}$ = 95% of $V_{\rm O}$ at I $_{\rm O}$ = 500 mA	1.2	1.5	_	А
Line Regulation	$\Delta V_{O(\Delta VI)}$	3.1 V $\leq$ V <sub>I</sub> = V <sub>S</sub> $\leq$ 3.5 V, I <sub>O</sub> = 300 mA	_	2.0	10	mV
Load Regulation	$\Delta V_{O(\Delta IO)}$	$0 \le I_0 \le 1 A$	—	10	20	mV
Dropout Voltage	V <sub>I</sub> min - V <sub>O</sub>	I <sub>0</sub> ≤ 1 A	—	0.55	1.2	V
Ground Terminal Current	I <sub>GND</sub>	I <sub>o</sub> = 0 mA	_	1.7	2.5	mA
	۱ <sub>Q</sub>	V <sub>E</sub> = 0 V, I <sub>O</sub> = 0 mA	_	_	1.0	μΑ
Rejection Ratio	PSRR	100 Hz ≤ f ≤ 120 Hz	_	60	_	dB
ENABLE Input Voltage V <sub>EH</sub>		Output On	2.0	—	_	V
	V <sub>EL</sub>	Output Off	_	—	0.8	V
ENABLE Input Current	I <sub>EH</sub>	V <sub>E</sub> = 2 V, Output On	_	30	80	μA
	I <sub>EL</sub>	V <sub>E</sub> = 0 V, Output Off	_	0	-5.0	μΑ
Thermal Protection Temp.	TJ		135	150	_	°C
Thermal Resistance	$R_{_{ ext{ hetaJL}}}$	To terminals 7 and 8		36		°C/W

Typical values are at  $T_A$  = +25°C and are given for circuit design information only.



TYPICAL CHARACTERISTICS at  $T_A = 25^{\circ}C$ 



**Overcurrent protection** 2.0 VI = VS = 3.2 V VI = VS = 5 V1.5 VI = VS = 6 VOUTPUT VOLTAGE 1.0 0.5 0 0 0.5 1.0 1.5 2.0 **OUTPUT CURRENT in AMPERES** Dwg. GK-027





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4







**GND** current

60 VI = VS = 3.3 V Io = 5 mA 50 ENABLE INPUT CURRENT in µA 40 30 20 10 0 0 0.5 1.0 1.5 2.0 2.5 3.0 ENABLE VOLTAGE in VOLTS Dwg. GK-023

**ENABLE** input current

#### APPLICATIONS INFORMATION

Thermal protection and heat sinking. Thermal protection circuitry turns off the device should the junction temperature rise above 135°C. This is intended only to protect the device from failures due to excessive junction temperatures and should not imply that high-temperature operation is permitted. Ambient temperature is affected by air circulation and proximity to other heat-producing components. Normal operation is resumed when the junction temperature is reduced. Output terminals 7 and 8 are the lead frame and substrate of the pass transistor and provide a low thermal-resistance path for heat sinking.

In general, the maximum ambient temperature has the most effect on determining the heat sinking that is needed to maintain a safe normal operating junction temperature. The maximum heat sinking thermal resistance  $(R_{\theta JA})$  can be calculated as

 $R_{_{\theta JA}} = (135 - T_{_A}) / I_{_O}(V_{_I} - 1.8)$ 

where  $T_A$  is the maximum ambient temperature in °C,  $I_O$  is the maximum output (load) current in amperes, and  $V_I$  is the maximum input voltage in volts.

The following graph gives the required copper foil area (soldered to leads 7 and 8) to provide the required thermal resistance. Note that more is always better and both sides of the printed wiring board can be used.

**ENABLE input.** The ENABLE input includes an internal pull-



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down resistor. If this terminal is not connected (open-circuit fault), the device output is turned off.

Overcurrent protection. The SI-3018LSA includes an overcurrent protection circuit, which limits the output current at start up. It thus cannot be used with

- 1) a constant-current load,
- 2) a power supply with positive and negative to a common load (center-tap type power supply),
- 3) a series power supply, or
- 4) a diode or resistor in series with the device ground to raise the output voltage.

Input voltage. Including ripple voltage and transients, the minimum input voltage should be greater than the sum of the output voltage and the maximum rated dropout voltage; the maximum input voltage must be less than the absolute maximum rated input voltage (16 V).

In most applications, the input voltage (terminal 1,  $V_{y}$ ) and the supply voltage (terminal 3,  $V_s$ ) are connected together.

**Output capacitor.** A 22 µF tantalum electrolytic capacitor is recommended between the output and ground. Very-low ESR capacitors should not be used.

**Input capacitor.** A 0.1  $\mu$ F to 10  $\mu$ F tantalum capacitor is recommended between the input and ground to prevent oscillation.



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#### Dimensions in Millimeters (controlling dimensions)



NOTES: 1. Exact body and lead configuration at vendor's option within limits shown.

- 2. Lead spacing tolerance is non-cumulative.
- 3. Leads 7 and 8 are internally connected together and provide heat sinking of the pass transistor.



**Tape and Reel Dimensions in Millimeters** 



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## LINEAR REGULATORS

#### IN ORDER OF 1) OUTPUT VOLTAGE AND 2) OUTPUT CURRENT

				Part	
Vo	Max I <sub>O</sub>	Max DC In	Max. Dropout Voltage	Number	Package
1.8 V	1.0 A	16 V	1.2 V @ 1.0 A	SI-3018LSA	8-Lead SOIC
2.5 V	1.0 A	16 V	800 mV @ 1.0 A	SI-3025LSA	8-Lead SOIC
3.3 V	1.0 A	16 V	800 mV @ 1.0 A	SI-3033LSA	8-Lead SOIC
3.3 V	1.5 A	20 V	500 mV @ 1.0 A	SI-3033C	5-Lead TO-220
5.0 V	1.0 A	25 V	500 mV @ 0.5 A	SI-3050N	TO-220
5.0 V *	1.5 A	35 V	1.0 V @ 1.5 A	SLA3001M	Power-Tab SIP
5.0 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3050C	5-Lead TO-220
5.0 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3051N	TO-220
5.0 V	2.0 A	25 V	500 mV @ 1.0 A	SI-3052V	TO-3P
7.7 V	15 mA	30 V	-	A8178LLT	SOT-89
9.0 V	1.0 A	30 V	500 mV @ 0.5 A	SI-3090N	TO-220
9.0 V *	1.5 A	35 V	1.0 V @ 1.5 A	SLA3001M	Power-Tab SIP
9.0 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3090C	5-Lead TO-220
9.0 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3091N	TO-220
12 V	1.0 A	30 V	500 mV @ 0.5 A	SI-3120N	TO-220
12 V *	1.5 A	35 V	1.0 V @ 1.5 A	SLA3001M	Power-Tab SIP
12 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3120C	5-Lead TO-220
12 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3121N	TO-220
12 V	2.0 A	30 V	500 mV @ 1.0 A	SI-3122V	TO-3P
15 V	1.0 A	35 V	500 mV @ 0.5 A	SI-3150N	TO-220
15 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3150C	5-Lead TO-220
15 V	1.5 A	35 V	500 mV @ 1.0 A	SI-3151N	TO-220
15 V	2.0 A	30 V	500 mV @ 1.0 A	SI-3152V	TO-3P
15.7 V †	1.0 A	35 V	1.0 V @ 1.0 A	SLA3002M	Power-Tab SIP
24 V	1.5 A	45 V	500 mV @ 1.0 A	SI-3240C	5-Lead TO-220
24 V	1.5 A	45 V	500 mV @ 1.0 A	SI-3241N	TO-220

 $\ast\;$  Three outputs, one each at 5 V, 9 V, and 12 V.

† Also includes two switching regulator outputs for 5 V at 500 mA and 9 V at 400 mA.

Also, see 83145 and 84145 Latched, Universal Input-Voltage Switches.



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